

COMBINATION VISIBLE AND INFRARED PIPE

This application is a continuation of U.S. Patent Application Ser. No. 09/861,207 filed May 18, 2001 and claims priority of U.K. Patent Application Ser. No. 001877.8 filed May 18, 5 2000.

This invention relates generally to the handling of both infrared light and visible light, utilizing a single light pipe. More particularly, this invention provides a construction for a component, and a method of operation for the component, such that the function of transporting light from an optically inaccessible, light-generating location to an optically accessible region on 10 the component can coexist with the infrared features of an appropriate transceiver device.

BACKGROUND OF THIS INVENTION

For various devices such as telephones, it is known to utilize light pipes extending from 15 internal, optically inaccessible locations to external, optically accessible locations. Such light pipes are used to conduct visible light in products requiring visible status indicators. Typically, light pipes of this kind terminate at a light diffuser.

We have determined that it is possible to modify light pipes in such a way that status 20 indication and infrared features can coexist within the same unit, thus leading to smaller product sizes and lower costs. These considerations are becoming increasingly important, as device portability becomes more desirable.

As a general principle, it is of advantage to have more integrated product designs, and 25 also the ability to add new features to existing components.

PRIOR ART

It is known to utilize a light pipe to transfer light energy from a source such as one or 30 more LEDs, located on a printed circuit board (PCB), up to a visually accessible surface of a product, where the light pipe typically ends at a light diffuser.

GENERAL DESCRIPTION OF THIS INVENTION

The present invention seeks to improve upon the prior art just mentioned, by allowing infrared energy and visible light to coexist and be handled within the same unit.

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More particularly, this invention provides, for use with a component defining a surface, the component including a printed circuit board supporting light-generating means, along with light-transporting means for conducting light from the light-generating means to a light diffuser adjacent the surface, the improvement wherein the light-transporting means is in the form of two 10 juxtaposed light pipe portions, and wherein an infrared transceiver module is coupled into both of the light pipe portions adjacent the light-generation means, the light pipe portions both transporting light to said light diffuser.

Further, this invention provides, in a component defining a surface and including a 15 printed circuit board supporting light-generating means, and further including light-transporting means for conducting light from the light generating means to a light diffuser adjacent the surface, an improved method of operation wherein two juxtaposed light pipe portions transport light to said light diffuser, and where an infrared transceiver module is coupled into both of the light pipe portions adjacent the light-generating means.

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GENERAL DESCRIPTION OF THE DRAWINGS

Three embodiments of this invention are illustrated in the accompanying drawings, in which like numerals denote like parts throughout the several views, and in which:

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Figure 1 is a sectioned, oblique view of a component representing the prior art;

Figure 2 is a schematic elevation showing a major component representative of the prior art;

Figure 3 is a further schematic diagram, useful to explain the theoretical background to this invention;

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Figure 4 is a schematic elevational view of a first embodiment of the major component which is the focus of this invention.

Figure 5 is a schematic elevational view of a second embodiment;

Figure 6 is a view similar to Figure 1, but showing the incorporation of the inventive structure into a component; and

Figure 7 is a schematic elevational view of a third embodiment.

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DETAILED DESCRIPTION OF THE DRAWINGS

Figure 1 illustrates how a light pipe 5 and a light diffuser 3 are currently used to direct light from two LEDs 6 located on a printed circuit board 8 (PCB) up to the surface 3a of a component 4. The PCB supports various electronic components 7 facing in the opposite direction from the surface of a component 4. An elastomeric strip 9 allows depression of a key button 2 to be sensed by detection circuitry on the PCB. The light pipe 5 performs the same function as the key buttons, in that both items bring product features out to convenient physical locations.

15 Figure 2 shows the prior art light pipe 5 in greater detail. Two LEDs 6 direct light energy up to through light pipe 5 to the diffuser 3 where it can be viewed. In this instance, the light pipe is shown to be of substantial size, since it conveys important information to the user (i.e., message waiting indicator, etc.). The curved parts visible at 5a in Figure 1 have been "straightened out" in Figure 2, in order to simplify the explanation of its use in an infrared

20 context.

An important aspect of the present invention is the modification of the construction of the light pipe such that, using the concept known as wavelength division multiplexing (WDM), it is possible to use the light pipe for transmission of visible wavelengths and transmission/reception of invisible (infrared) wavelengths. For a better understanding of this concept, attention is 25 directed to Figure 3.

Wavelength division multiplexing has its origins in the fiber optic communications field. Figure 3 shows two transmitting light sources 10, 13, and detectors 11, 12 operating at spectral wavelengths coupled at 15 into a single fibre optical cable 14 (effectively reducing the number of fibres required in an installation).

Internal reflections from the transmitter 10 travelling down the cable 14 and subsequently picked up by the receiver 12 are ignored because of the receiver's sensitivity to its optimal wavelength.

The unique aspect of the present invention is that by modifying the light pipe only, a new 5 feature can be incorporated into a product, without requiring changes to the external plastics.

Illustrated in Figure 4 is a method of coupling an infrared transceiver into the previously described light pipe. An infrared transceiver module 16 is coupled into the light pipe 18, which has been moulded to conform to the shape of the lenses of the transceiver. A slot 17 is provided within the light pipe material, in order to separate the infrared transmitter energy and prevent it 10 from being reflected back to the receiver immediately adjacent to it. The top of the light pipe is moulded to provide a lenticular protuberance 19 so that it distributes/collects infrared energy over a wide code angle. For illustrative purposes, the drawings show transmitted energy at two separate spectral wavelengths as arrows at different lengths. The short arrows represent photons emitted by the visible red LEDs (approximately 660 nm) and the longer dashed arrows are 15 photons emitted by the invisible infrared LEDs (approximately 890 nm).

In Figure 4, the light pipe consists of two separate pieces joined together by the upper light diffuser 3. As an alternative to this approach, the embodiment illustrated in Figure 5 incorporates an intermittent slot 20 into the light pipe, so that a single light pipe provides optical separation between the halves. The narrow aperture provided by the slots minimizes energy 20 coupling between the halves, and yet allows the piece to be manufactured as a single unit.

Figure 5 also shows alignment pins 21 moulded into the light pipe 18. These pins 21 fit into holes drilled in the PCB 8, and allow accurate positioning of the light pipe 18 over the optical devices 6.

It is expected that the increased separation between the infrared transceiver and the front 25 of the product created by using the inventive light pipe 18 will result in greater ESD immunity.

Figure 6 shows how an infrared transceiver 16 could be incorporated with a specially modified light pipe into the prior art product shown in Figure 1.

Further variations of this invention are possible. For example, Figure 7 shows the concept of a single piece moulded plastic light pipe 18a with a number of slots, potentially 30 simplifying the design of LED arrays within products.

While several embodiments of this invention have been illustrated in the accompanying drawings and described hereinabove, it will be evident to those skilled in the art that changes and modification may be made therein without departing from the essence of this invention, as set forth in the appended claims.